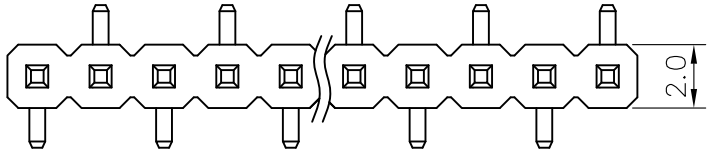
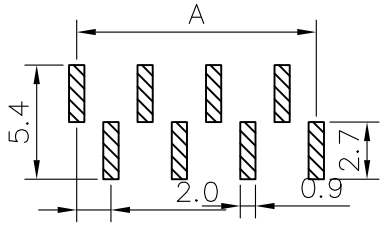
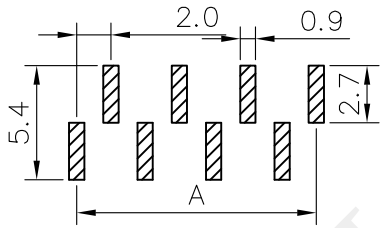


Type B（右前左后）

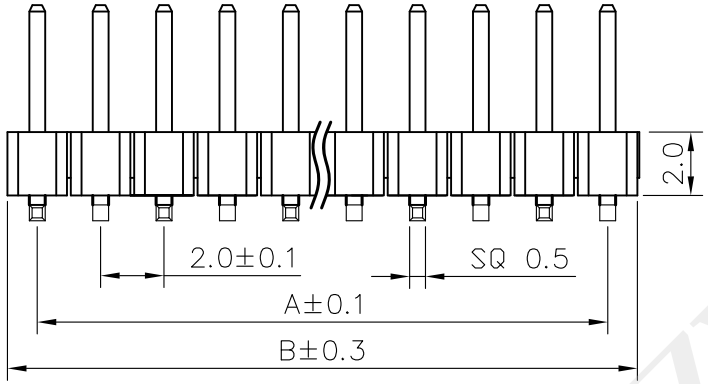


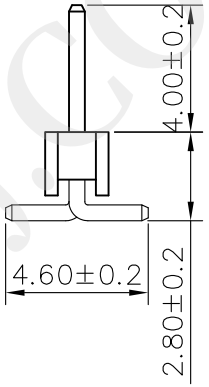
Type A（左前右后）





RECOMMEND P.C.B LAYOUT
PCB TOLERANCE:±0.05 (TOP VIEW)





No. of	DIM.A	DIM.B	No. of	DIM.A	DIM.B	No. of	DIM.A	DIM.B	No. of	DIM.A	DIM.B
1	0.00	2.00	11	20.00	22.00	21	40.00	42.00	31	60.00	62.00
2	2.00	4.00	12	22.00	24.00	22	42.00	44.00	32	62.00	64.00
3	4.00	6.00	13	24.00	26.00	23	44.00	46.00	33	64.00	66.00
4	6.00	8.00	14	26.00	28.00	24	46.00	48.00	34	66.00	68.00
5	8.00	10.00	15	28.00	30.00	25	48.00	50.00	35	68.00	70.00
6	10.00	12.00	16	30.00	32.00	26	50.00	52.00	36	70.00	72.00
7	12.00	14.00	17	32.00	34.00	27	52.00	54.00	37	72.00	74.00
8	14.00	16.00	18	34.00	36.00	28	54.00	56.00	38	74.00	76.00
9	16.00	18.00	19	36.00	38.00	29	56.00	58.00	39	76.00	78.00
10	18.00	20.00	20	38.00	40.00	30	58.00	60.00	40	78.00	80.00

SPECIFICATIONS

Current Rating: 1.5 Amps
Insulation Resistance: 1000MΩ Min
Contact Resistance: 20mΩ Max
Withstanding Voltage: AC 500V
Operation Temperature: -40° to+105°
Contact Material: Brass
Standard: PA6T
Insrlator Material: Polyester(UL 94V-0)
Contact Plating: Gold Flash
Max.Processing Temp: 240° C for30-60seconds
(260° C for5seconds)

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY: 陈一鸣	DATE: 2014-02-23	PART NAME: 2.0PH 1xnPin H2.0 SMT L8.6
	CHECKED BY: 马跃	DATE: 2014-02-23	PART NO. HYC2-20M200-1XXA(B)
UNIT: mm [inch]	APPROVED BY: 邱敏	DATE: 2014-02-23	MOLD NO.
SCALE:1:1 SIZE: A4			DRAW NO: HYC-2104281620
			SHEET NO. 1 OF 1

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